SLLS077B - FEBRUARY 1990 - REVISED MAY 1995

- Meets or Exceeds the Requirements of IBM 360/370 Input/Output Interface Specification GA22-6974-3
- Minimum Output Voltage of 3.11 V at I_{OH} = −59.3 mA
- Fault-Flag Circuit Output Signals Driver Output Fault
- Fault-Detection Current-Limit Circuit Minimizes Power Dissipation During a Fault Condition
- Common Enable and Common Fault Flag
- Designed to Be an Improved Replacement for the MC3485

16 V_{CC} 1W ∏ 15∏ 4Y 1A 🛮 3 14**∏** 4W G 13 **1** 4A 12 | F 2A 🛮 11 🛮 3A 2W Π 6 2Y 🛮 10 3W 9**∏** 3Y GND []

D OR N PACKAGE (TOP VIEW)

description

The SN75130 quadruple line driver is designed to meet the IBM 360/370 I/O specification GA22-6974-3. The output voltage is 3.11 V minimum (at $I_{OH} = -59.3$ mA) over the recommended ranges of supply voltage (4.5 V to 5.95 V) and temperature (0°C to 70°C). Driver outputs use a fault-detection current-limit circuit to allow high drive current but still minimize power dissipation when the output is shorted to ground. The SN75130 is compatible with standard TTL logic and supply voltages.

Fault-flag circuitry is designed to sense and signal a line short on any Y line. Upon detecting an output fault condition, the fault-flag circuit forces the driver output into the off (low) state and signals a fault condition by causing the fault-flag output to go low.

The SN75130 can drive a $50-\Omega$ load or a $90-\Omega$ load as used in many I/O systems. Optimum performance can be achieved when the device is used with either the SN75128 or SN75129 line receiver. Also, see the SN751730 for new 360/370 interface designs.

The SN75130 is characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each driver)

	`		,		
INP	UTS	OUTPUTS			
G†	Α	Υ	F	W	
L	Х	L	Н	Н	
Х	L	L	Н	Н	
Н	Н	Н	Н	L	
Н	Н	s	L	Н	

H = high level, L = low level, X = irrelevant,



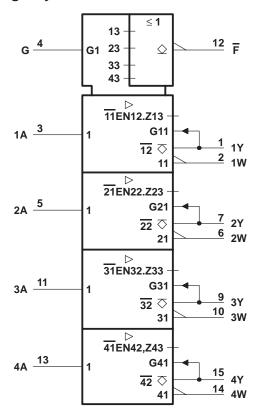
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S = shorted to ground

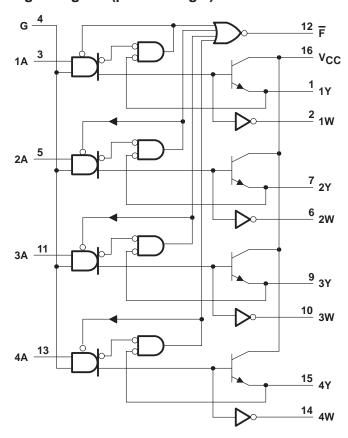
[†]G and \overline{F} are common to the four drivers. If any of the four Y outputs is shorted, the fault flag responds.

logic symbol†

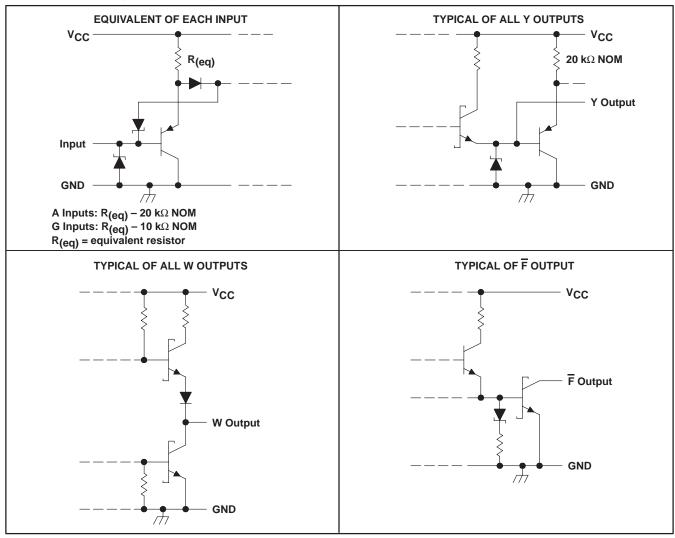


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC}	
Input voltage, V _I	7 V
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T _A	0°C to 70°C
Storage temperature range, T _{stg}	65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{\scriptsize A}} \le 25^{\circ}\mbox{\scriptsize C}$ POWER RATING	OPERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING		
D	950 mW	7.6 mW/°C	608 mW		
N	1150 mW	9.2 mW/°C	736 mW		

recommended operating conditions

	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.5	5	5.95	V
High-level input voltage, VIH	2			V
Low-level input voltage, V _{IL}			0.8	V
High-level output current, I _{OH}			-59.3	mA
Operating free-air temperature, T _A	0		70	°C

electrical characteristics over recommended operating free-air temperature range

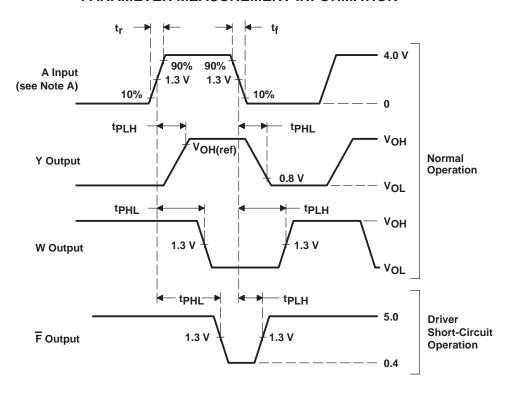
PARAMETER			TEST CONDITIONS			MIN	MAX	UNIT	
VIK	Input clamp voltage	A,G	I _I = –18 mA				-1.5	V	
		Υ	$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -59.3 \text{ mA},$	V _{IH} = 2 V	3.11			
Vон	High-level output voltage	Υ	$V_{CC} = 5.25 \text{ V},$	$I_{OH} = -41 \text{ mA},$	V _{IH} = 2 V	3.9		V	
		W	$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -400 \mu A$,	V _{IH} = 2 V	2.5			
		Υ	$V_{CC} = 5.5 \text{ V},$	$I_{OL} = -240 \mu A$,	V _{IL} = 0.8 V		0.15		
\/o.	Low-level output voltage	Υ	$V_{CC} = 5.95 \text{ V},$	$I_{OL} = -1 \text{ mA},$	V _{IL} = 0.8 V		0.15	V	
VOL	Low-level output voltage	F	$V_{CC} = 4.5 \text{ V},$	$I_{OL} = 8 \text{ mA},$	Y at 0 V		0.5	V	
		W	$V_{CC} = 4.5 \text{ V},$	$I_{OL} = 8 \text{ mA}$			0.5		
lo	Off-state output current	Υ	$V_{CC} = 4.5 \text{ V},$	$V_{IL} = 0$,	V _O = 3.11 V		100	μА	
IO(off)	On-state output current	Υ	$V_{CC} = 0$,	$V_{IL} = 0$,	V _O = 3.11 V		200	μΑ	
IOH	High-level output current	F	$V_{CC} = 5.95 \text{ V},$	V _{OH} = 5.95 V			100	μΑ	
١.	Input current	Α	V _{CC} = 4.5 V,	V _{IH} = 5.5 V			100	μΑ	
11		G	VCC = 4.5 V,				400		
l	High-level input current	А	V00 - 45 V	\/ 2.7\/			20		
ΊΗ	rigii-ievei iriput curierit	G	$V_{CC} = 4.5 \text{ V},$	VIH = 2.7 V			80	μΑ	
I	Low-level input current	Α	\/oo - 5 05 \/	\/u = 0.4\/	-041/		250		
ΊL	Low-lever input current	G	$V_{CC} = 5.95 \text{ V},$	$V_{IL} = 0.4 V$			-1000	μА	
	Short-circuit output current	Υ	V _{CC} = 5.5 V,	V _O = 0			-5		
		W	vCC = 5.5 v,			-15	-100	mA	
los		Υ	\/oo - 5 05 \/	V _O = 0			-5		
		W	$V_{CC} = 5.95 \text{ V},$			-15	-110		
loou	Supply current, all outputs high		$V_{CC} = 5.5 \text{ V},$	V _I = 2 V			75	mA	
Іссн	Supply current, an outputs flight		$V_{CC} = 5.95 \text{ V},$	V _I = 2 V			85	IIIA	
looi	Supply ourront. V outputs low		$V_{CC} = 5.5 \text{ V},$	V _I = 0.8 V			55	mA	
ICCL	ICCL Supply current, Y outputs low		$V_{CC} = 5.95 \text{ V},$	V _I = 0.8 V			70	IIIA	

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switching characteristics over recommended operating free-air temperature range

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		MIN	MAX	UNIT
tPLH	Propagation delay time, low- to high-level output						40	ns
tPHL	Propagation delay time, high- to low-level output	Α	Y	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$ $C_{L} = 50 \text{ pF},$ Input f = 1 MHz,	VOH(ref) = 3.11 V, R _L = 50 Ω , See Figures 1 and 2		37	ns
t <u>PLH</u> tPHL	Ratio of propagation delay times					0.3	3	
^t PLH	Propagation delay time, low- to high-level output	A	Y	V _{CC} = 5.25 V to 5.59 V, C _L = 50 pF,	$V_{OH(ref)} = 3.9 \text{ V},$ $R_{I} = 90 \Omega,$		45	ns
^t PHL	Propagation delay time, high- to low-level output	A	'	Input f = 5 MHz,	See Figures 1 and 2		45	ns
tPLH	Propagation delay time, low- to high-level output	А	W	V _{CC} = 5 V, C _L = 15 pF,	$R_L = 2 \text{ k}\Omega$, See Figures 1 and 2		45	ns
tPHL	Propagation delay time, high- to low-level output						28	ns
^t PLH	Propagation delay time, low- to high-level output	A	F	V _{CC} = 5 V, C _L = 15 pF,	R _L = 2 kΩ,		60	ns
tPHL	Propagation delay time, high- to low-level output	Α		C _L = 15 pF,	See Figures 1 and 2		100	ns

PARAMETER MEASUREMENT INFORMATION

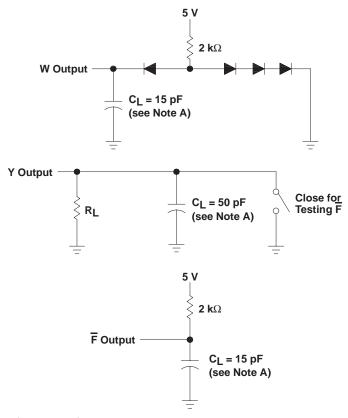


NOTE A: The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%, $t_f \le 6$ ns, $t_f \le$

Figure 1. Input and Output Voltage Waveforms



PARAMETER MEASUREMENT INFORMATION



NOTE A: C_L includes probe and stray capacitance.

Figure 2. Switching Characteristics Load Circuits

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